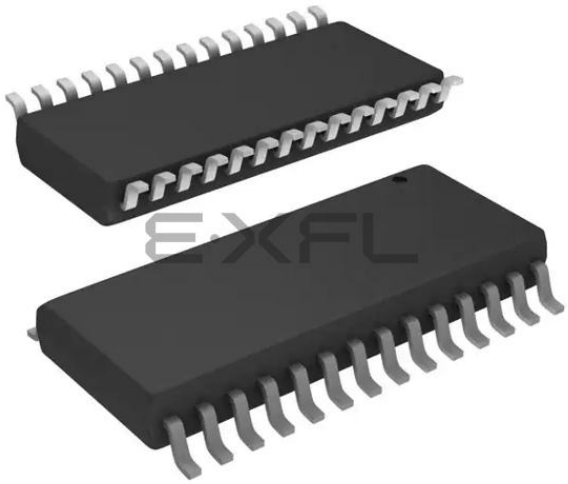

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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	16-Bit
Speed	32MHz
Connectivity	I²C, IrDA, LINbus, SmartCard, SPI, UART/USART
Peripherals	AES, Brown-out Detect/Reset, DMA, I²S, HLVD, POR, PWM, WDT
Number of I/O	21
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 3.6V
Data Converters	A/D 10x10b/12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	28-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic24fj64ga202-i-so

TABLE 1-2: DEVICE FEATURES FOR THE PIC24FJ128GA204 FAMILY: 28-PIN DEVICES

Features	PIC24FJ64GA202	PIC24FJ128GA202
Operating Frequency	DC – 32 MHz	
Program Memory (bytes)	64K	128K
Program Memory (instructions)	22,016	44,032
Data Memory (bytes)	8K	
Interrupt Sources (soft vectors/ NMI traps)	71 (67/4)	
I/O Ports	Ports A, B	
Total I/O Pins	21	
Remappable Pins	16 (15 I/Os, 1 Input only)	
Timers: Total Number (16-bit)	5(1)	
32-Bit (from paired 16-bit timers)	2	
Input Capture w/Timer Channels	6(1)	
Output Compare/PWM Channels	6(1)	
Input Change Notification Interrupt	21	
Serial Communications: UART	4(1)	
SPI (3-wire/4-wire)	3(1)	
I^2C™	2	
Digital Signal Modulator (DSM)	Yes	
JTAG Boundary Scan	Yes	
12-Bit SAR Analog-to-Digital Converter (A/D) (input channels)	10	
Analog Comparators	3	
CTMU Interface	10 Channels	
Resets (and Delays)	Core POR, VDD POR, VBAT POR, BOR, RESET Instruction, MCLR, WDT, Illegal Opcode, REPEAT Instruction, Hardware Traps, Configuration Word Mismatch (OST, PLL Lock)	
Instruction Set	76 Base Instructions, Multiple Addressing Mode Variations	
Packages	28-Pin SPDIP, SSOP, SOIC and QFN-S	
Cryptographic Engine	Supports AES with 128, 192 and 256-Bit Key, DES and TDES, True Random and Pseudorandom Number Generator, On-Chip OTP Storage	
RTCC	Yes	

Note 1: Peripherals are accessible through remappable pins.

TABLE 5-1: DMA CHANNEL TRIGGER SOURCES

CHSEL<5:0>	Trigger (Interrupt)	CHSEL<5:0>	Trigger (Interrupt)
000000	(Unimplemented)	100000	UART2 Transmit
000001	SPI3 General Event	100001	UART2 Receive
000010	I2C1 Slave Event	100010	External Interrupt 2
000011	UART4 Transmit	100011	Timer5
000100	UART4 Receive	100100	Timer4
000101	UART4 Error	100101	Output Compare 4
000110	UART3 Transmit	100110	Output Compare 3
000111	UART3 Receive	100111	DMA Channel 2
001000	UART3 Error	101000	I2C2 Slave Event
001001	CTMU Event	101001	External Interrupt 1
001010	HLVD	101010	Interrupt-on-Change
001011	CRC Done	101011	Comparators Event
001100	UART2 Error	101100	SPI3 Receive Event
001101	UART1 Error	101101	I2C1 Master Event
001110	RTCC	101110	DMA Channel 1
001111	DMA Channel 5	101111	A/D Converter
010000	External Interrupt 4	110000	UART1 Transmit
010001	External Interrupt 3	110001	UART1 Receive
010010	SPI2 Receive Event	110010	SPI1 Transmit Event
010011	I2C2 Master Event	110011	SPI1 General Event
010100	DMA Channel 4	110100	Timer3
010101	EPMP	110101	Timer2
010110	SPI1 Receive Event	110110	Output Compare 2
010111	Output Compare 6	110111	Input Capture 2
011000	Output Compare 5	111000	DMA Channel 0
011001	Input Capture 6	111001	Timer1
011010	Input Capture 5	111010	Output Compare 1
011011	Input Capture 4	111011	Input Capture 1
011100	Input Capture 3	111100	External Interrupt 0
011101	DMA Channel 3	111101	Reserved
011110	SPI2 Transmit Event	111110	SPI3 Transmit Event
011111	SPI2 General Event	111111	Cryptographic Done

REGISTER 7-1: RCON: RESET CONTROL REGISTER (CONTINUED)

bit 5 **SWDTEN:** Software Enable/Disable of WDT bit(4)
1 = WDT is enabled
0 = WDT is disabled

bit 4 **WDTO:** Watchdog Timer Time-out Flag bit(1)
1 = WDT time-out has occurred
0 = WDT time-out has not occurred

bit 3 **SLEEP:** Wake from Sleep Flag bit(1)
1 = Device has been in Sleep mode
0 = Device has not been in Sleep mode

bit 2 **IDLE:** Wake from Idle Flag bit(1)
1 = Device has been in Idle mode
0 = Device has not been in Idle mode

bit 1 **BOR:** Brown-out Reset Flag bit(1)
1 = A Brown-out Reset has occurred (also set after a Power-on Reset)
0 = A Brown-out Reset has not occurred

bit 0 **POR:** Power-on Reset Flag bit(1)
1 = A Power-on Reset has occurred
0 = A Power-on Reset has not occurred

Note 1: All of the Reset status bits may be set or cleared in software. Setting one of these bits in software does not cause a device Reset.

2: If the $\overline{\text{LPCFG}}$ Configuration bit is '1' (unprogrammed), the retention regulator is disabled and the RETEN bit has no effect.

3: Re-enabling the regulator after it enters Standby mode will add a delay, T_{VREG}, when waking up from Sleep. Applications that do not use the voltage regulator should set this bit to prevent this delay from occurring.

4: If the FWDTEN Configuration bit is '1' (unprogrammed), the WDT is always enabled**,** regardless of the SWDTEN bit setting.

REGISTER 8-4: INTCON2: INTERRUPT CONTROL REGISTER 2

R/W-0	R-0, HSC	U-0	U-0	U-0	U-0	U-0	U-0
ALTIVT	DISI	—	—	—	—	—	—
bit 15							bit 8

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	—	INT4EP	INT3EP	INT2EP	INT1EP	INT0EP
bit 7							bit 0

Legend:	HSC = Hardware Settable/Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **ALTIVT:** Enable Alternate Interrupt Vector Table bit
1 = Uses Alternate Interrupt Vector Table
0 = Uses standard (default) Interrupt Vector Table

bit 14 **DISI:** DISI Instruction Status bit
1 = DISI instruction is active
0 = DISI instruction is not active

bit 13-5 **Unimplemented:** Read as '0'

bit 4 **INT4EP:** External Interrupt 4 Edge Detect Polarity Select bit
1 = Interrupt on negative edge
0 = Interrupt on positive edge

bit 3 **INT3EP:** External Interrupt 3 Edge Detect Polarity Select bit
1 = Interrupt on negative edge
0 = Interrupt on positive edge

bit 2 **INT2EP:** External Interrupt 2 Edge Detect Polarity Select bit
1 = Interrupt on negative edge
0 = Interrupt on positive edge

bit 1 **INT1EP:** External Interrupt 1 Edge Detect Polarity Select bit
1 = Interrupt on negative edge
0 = Interrupt on positive edge

bit 0 **INT0EP:** External Interrupt 0 Edge Detect Polarity Select bit
1 = Interrupt on negative edge
0 = Interrupt on positive edge

REGISTER 8-5: IFS0: INTERRUPT FLAG STATUS REGISTER 0 (CONTINUED)

bit 2 **OC1IF:** Output Compare Channel 1 Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 1 **IC1IF:** Input Capture Channel 1 Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 0 **INT0IF:** External Interrupt 0 Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

REGISTER 8-42: IPC22: INTERRUPT PRIORITY CONTROL REGISTER 22

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
—	SPI3TXIP2	SPI3TXIP1	SPI3TXIP0	—	SPI3IP2	SPI3IP1	SPI3IP0
bit 15							bit 8

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
—	U4TXIP2	U4TXIP1	U4TXIP0	—	U4RXIP2	U4RXIP1	U4RXIP0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **Unimplemented:** Read as '0'

bit 14-12 **SPI3TXIP<2:0>:** SPI3 Transmit Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 11 **Unimplemented:** Read as '0'

bit 10-8 **SPI3IP<2:0>:** SPI3 General Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 7 **Unimplemented:** Read as '0'

bit 6-4 **U4TXIP<2:0>:** UART4 Transmitter Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 3 **Unimplemented:** Read as '0'

bit 2-0 **U4RXIP<2:0>:** UART4 Receiver Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

10.5.2 WAKE-UP FROM VBAT MODES

When VDD is restored to a device in VBAT mode, it automatically wakes. Wake-up occurs with a POR, after which, the device starts executing code from the Reset vector. All SFRs, except the Deep Sleep Semaphores, are reset to their POR values. If the RTCC was not configured to run during VBAT mode, it will remain disabled and RTCC will not run. Wake-up timing is similar to that for a normal POR.

To differentiate a wake-up from VBAT mode from other POR states, check the VBAT status bit (RCON2<0>). If this bit is set while the device is starting to execute the code from the Reset vector, it indicates that there has been an exit from VBAT mode. The application must clear the VBAT bit to ensure that future VBAT wake-up events are captured.

If a POR occurs without a power source connected to the VBAT pin, the VBPOR bit (RCON2<1>) is set. If this bit is set on a Power-on Reset, it indicates that a battery needs to be connected to the VBAT pin.

In addition, if the VBAT power source falls below the level needed for Deep Sleep Semaphore operation while in VBAT mode (e.g., the battery has been drained), the VBPOR bit will be set. VBPOR is also set when the microcontroller is powered up the very first time, even if power is supplied to VBAT.

10.5.3 I/O PINS DURING VBAT MODES

All I/O pins switch to Input mode during VBAT mode. The only exceptions are the SOSCI and SOSCO pins, which maintain their states if the Secondary Oscillator is being used as the RTCC clock source. It is the user's responsibility to restore the I/O pins to their proper states, using the TRISx and LATx bits, once VDD has been restored.

10.5.4 SAVING CONTEXT DATA WITH THE DSGPRx REGISTERS

As with Deep Sleep mode (i.e., without the low-voltage/retention regulator), all SFRs are reset to their POR values after VDD has been restored. Only the Deep Sleep Semaphore registers are preserved. Applications which require critical data to be saved should save it in DSGPR0 and DSGPR1.

Note:	If the VBAT mode is not used, it is recommended to connect the VBAT pin to VDD.

The POR should be enabled for the reliable operation of the VBAT.

REGISTER 11-12: RPINR18: PERIPHERAL PIN SELECT INPUT REGISTER 18

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	U1CTSR5	U1CTSR4	U1CTSR3	U1CTSR2	U1CTSR1	U1CTSR0
bit 15							bit 8

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	U1RXR5	U1RXR4	U1RXR3	U1RXR2	U1RXR1	U1RXR0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-14 **Unimplemented:** Read as ‘0’

bit 13-8 **U1CTSR<5:0>:** Assign UART1 Clear-to-Send ($\overline{\text{U1CTS}}$) to Corresponding RPn or RPIn Pin bits

bit 7-6 **Unimplemented:** Read as ‘0’

bit 5-0 **U1RXR<5:0>:** Assign UART1 Receive (U1RX) to Corresponding RPn or RPIn Pin bits

REGISTER 11-13: RPINR19: PERIPHERAL PIN SELECT INPUT REGISTER 19

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	U2CTSR5	U2CTSR4	U2CTSR3	U2CTSR2	U2CTSR1	U2CTSR0
bit 15							bit 8

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	U2RXR5	U2RXR4	U2RXR3	U2RXR2	U2RXR1	U2RXR0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-14 **Unimplemented:** Read as ‘0’

bit 13-8 **U2CTSR<5:0>:** Assign UART2 Clear-to-Send ($\overline{\text{U2CTS}}$) to Corresponding RPn or RPIn Pin bits

bit 7-6 **Unimplemented:** Read as ‘0’

bit 5-0 **U2RXR<5:0>:** Assign UART2 Receive (U2RX) to Corresponding RPn or RPIn Pin bits

REGISTER 11-35: RPOR12: PERIPHERAL PIN SELECT OUTPUT REGISTER 12(1)

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP25R5	RP25R4	RP25R3	RP25R2	RP25R1	RP25R0
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP24R5	RP24R4	RP24R3	RP24R2	RP24R1	RP24R0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-14 **Unimplemented:** Read as ‘0’

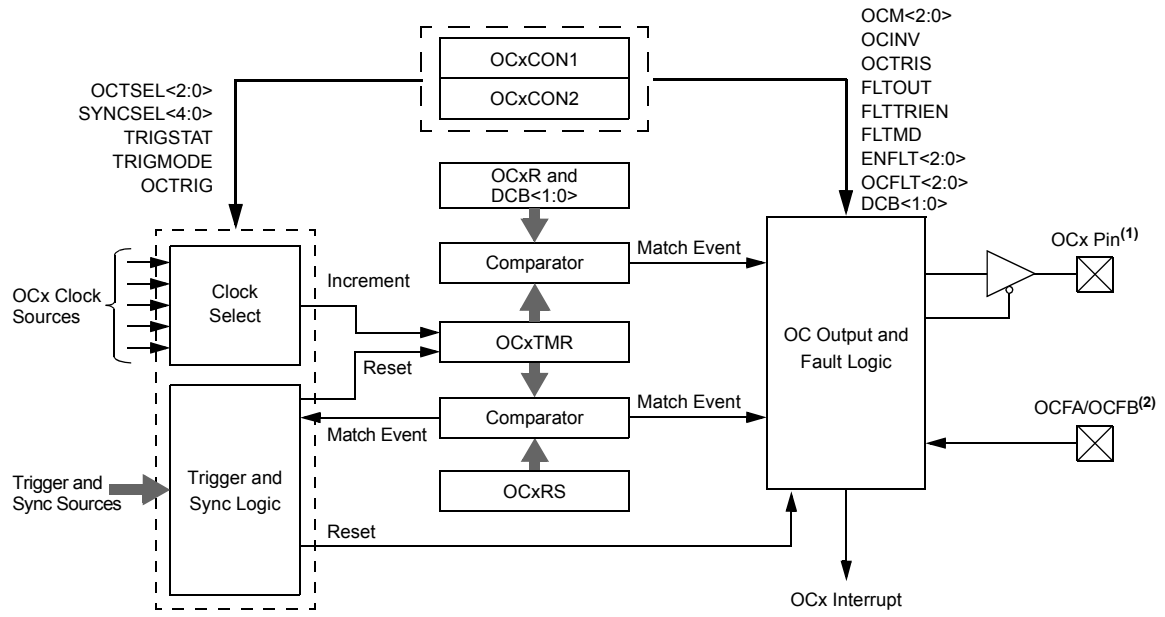
bit 13-8 **RP25R<5:0>:** RP25 Output Pin Mapping bits
Peripheral Output Number n is assigned to pin, RP25 (see Table 11-4 for peripheral function numbers).

bit 7-6 **Unimplemented:** Read as ‘0’

bit 5-0 **RP24R<5:0>:** RP24 Output Pin Mapping bits
Peripheral Output Number n is assigned to pin, RP24 (see Table 11-4 for peripheral function numbers).

Note 1: These pins are not available in 28-pin devices.

FIGURE 15-1: OUTPUT COMPARE x BLOCK DIAGRAM (16-BIT MODE)



Note 1: The OCx outputs must be assigned to an available RPn pin before use. For more information, see **Section 11.4 "Peripheral Pin Select (PPS)".**

2: The OCFA/OCFB Fault inputs must be assigned to an available RPn/RPIn pin before use. For more information, see **Section 11.4 "Peripheral Pin Select (PPS)"**.

15.2 Compare Operations

In Compare mode (Figure 15-1), the output compare module can be configured for single-shot or continuous pulse generation. It can also repeatedly toggle an output pin on each timer event.

To set up the module for compare operations:

1. Configure the OCx output for one of the available Peripheral Pin Select pins.
2. Calculate the required values for the OCxR and (for Double Compare modes) OCxRS Duty Cycle registers:
   a) Determine the instruction clock cycle time. Take into account the frequency of the external clock to the timer source (if one is used) and the timer prescaler settings.
   b) Calculate the time to the rising edge of the output pulse relative to the timer start value (0000h).
   c) Calculate the time to the falling edge of the pulse based on the desired pulse width and the time to the rising edge of the pulse.
3. Write the rising edge value to OCxR and the falling edge value to OCxRS.
4. Set the Timer Period register, PRy, to a value equal to or greater than the value in OCxRS.
5. Set the OCM<2:0> bits for the appropriate compare operation ('0xx').
6. For Trigger mode operations, set OCTRIG to enable Trigger mode. Set or clear TRIGMODE to configure trigger operation and TRIGSTAT to select a hardware or software trigger. For Synchronous mode, clear OCTRIG.
7. Set the SYNCSEL<4:0> bits to configure the trigger or synchronization source. If free-running timer operation is required, set the SYNCSELx bits to '00000' (no sync/trigger source).
8. Select the time base source with the OCTSEL<2:0> bits. If necessary, set the TON bit for the selected timer, which enables the compare time base to count. Synchronous mode operation starts as soon as the time base is enabled; Trigger mode operation starts after a trigger source event occurs.

16.5 Audio Mode

To set up the SPIx module for Audio mode:

1. Clear the SPIxBUFL and SPIxBUFH registers.
2. If using interrupts:
   a) Clear the interrupt flag bits in the respective IFSx register.
   b) Set the interrupt enable bits in the respective IECx register.
   a) Write the SPIxIP<2:0> bits in the respective IPCx register to set the interrupt priority.
3. Write the desired settings to the SPIxCON1L, SPIxCON1H and SPIxCON2L registers with AUDEN (SPIxCON1H<15>) = 1.
4. Clear the SPIROV bit (SPIxSTATL<6>).
5. Enable SPIx operation by setting the SPIEN bit (SPIxCON1L<15>).
6. Write the data to be transmitted to the SPIxBUFL and SPIxBUFH registers. Transmission (and reception) will start as soon as data is written to the SPIxBUFL and SPIxBUFH registers.

16.6 Registers

The SPI module consists of the following Special Function Registers (SFRs):

- SPIxCON1L, SPIxCON1H and SPIxCON2L: SPIx Control Registers (Register 16-1, Register 16-2 and Register 16-3)
- SPIxSTATL and SPIxSTATH: SPIx Status Registers (Register 16-4 and Register 16-5)
- SPIxBUFL and SPIxBUFH: SPIx Buffer Registers
- SPIxBRGL and SPIxBRGH: SPIx Baud Rate Registers
- SPIxIMSKL and SPIxIMSKH: SPIx Interrupt Mask Registers (Register 16-6 and Register 16-7)
- SPIxURDTL and SPIxURDTH: SPIx Underrun Data Registers

REGISTER 16-1: SPIxCON1L: SPIx CONTROL REGISTER 1 LOW

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
SPIEN	—	SPISIDL	DISSDO	MODE32(1,4)	MODE16(1,4)	SMP	CKE(1)
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
SSEN(2)	CKP	MSTEN	DISSDI	DISSCK	MCLKEN(3)	SPIFE	ENHBUF
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **SPIEN:** SPIx On bit
1 = Enables module
0 = Turns off and resets module, disables clocks, disables interrupt event generation, allows SFR modifications

bit 14 **Unimplemented:** Read as '0'

bit 13 **SPISIDL:** SPIx Stop in Idle Mode bit
1 = Halts in CPU Idle mode
0 = Continues to operate in CPU Idle mode

bit 12 **DISSDO:** Disable SDOx Output Port bit
1 = SDOx pin is not used by the module; pin is controlled by the port function
0 = SDOx pin is controlled by the module

Note 1: When AUDEN = 1, this module functions as if CKE = 0, regardless of its actual value.
2: When FRMEN = 1, SSEN is not used.
3: MCLKEN can only be written when the SPIEN bit = 0.
4: This channel is not meaningful for DSP/PCM mode as LRC follows FRMSYPW.

17.2 Setting Baud Rate when Operating as a Bus Master

To compute the Baud Rate Generator reload value, use Equation 17-1.

EQUATION 17-1: COMPUTING BAUD RATE RELOAD VALUE(1)

$$I2CxBRG = \left(\left(\frac{1}{FSCL} - PGDx\right) \times \frac{FCY}{2}\right) - 2$$

Note 1: Based on FCY = FOSC/2; Doze mode and PLL are disabled.

17.3 Slave Address Masking

The I2CxMSK register (Register 17-4) designates address bit positions as "don't care" for both 7-Bit and 10-Bit Addressing modes. Setting a particular bit location (= 1) in the I2CxMSK register causes the slave module to respond, whether the corresponding address bit value is a '0' or a '1'. For example, when I2CxMSK is set to '0010000000', the slave module will detect both addresses, '0000000000' and '0010000000'.

To enable address masking, the Intelligent Peripheral Management Interface (IPMI) must be disabled by clearing the STRICT bit (I2CxCONL<11>).

Note: As a result of changes in the I²C™ protocol, the addresses in Table 17-1 are reserved and will not be Acknowledged in Slave mode. This includes any address mask settings that include any of these addresses.

TABLE 17-1: I2Cx RESERVED ADDRESSES(1)

Slave Address	R/$\overline{W}$ Bit	Description
0000 000	0	General Call Address(2)
0000 000	1	Start Byte
0000 001	x	Cbus Address
0000 01x	x	Reserved
0000 1xx	x	HS Mode Master Code
1111 0xx	x	10-Bit Slave Upper Byte(3)
1111 1xx	x	Reserved

Note 1: The address bits listed here will never cause an address match independent of address mask settings.
2: This address will be Acknowledged only if GCEN = 1.
3: A match on this address can only occur on the upper byte in 10-Bit Addressing mode.

REGISTER 22-1: CRYCONL: CRYPTOGRAPHIC CONTROL LOW REGISTER

R/W-0	U-0	R/W-0	R/W-0(1)	R/W-0(1)	R/W-0(1)	U-0	R/W-0, HC(1)
CRYON	—	CRYSIDL(3)	ROLLIE	DONEIE	FREEIE	—	CRYGO
bit 15							bit 8

R/W-0(1)	R/W-0(1)	R/W-0(1)	R/W-0(1)	R/W-0(1)	R/W-0(1)	R/W-0(1)	R/W-0(1)
OPMOD3(2)	OPMOD2(2)	OPMOD1(2)	OPMOD0(2)	CPHRSEL(2)	CPHRMOD2(2)	CPHRMOD1(2)	CPHRMOD0(2)
bit 7							bit 0

Legend:	HC = Hardware Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **CRYON:** Cryptographic Enable bit
1 = Module is enabled
0 = Module is disabled

bit 14 **Unimplemented:** Read as '0'

bit 13 **CRYSIDL:** Cryptographic Stop in Idle Control bit(3)
1 = Stops module operation in Idle mode
0 = Continues module operation in Idle mode

bit 12 **ROLLIE:** CRYTXTB Rollover Interrupt Enable bit(1)
1 = Generates an interrupt event when the counter portion of CRYTXTB rolls over to '0'
0 = Does not generate an interrupt event when the counter portion of CRYTXTB rolls over to '0'

bit 11 **DONEIE:** Operation Done Interrupt Enable bit(1)
1 = Generates an interrupt event when the current cryptographic operation completes
0 = Does not generate an interrupt event when the current cryptographic operation completes; software must poll the CRYGO or CRYBSY bit to determine when current cryptographic operation is complete

bit 10 **FREEIE:** Input Text Interrupt Enable bit(1)
1 = Generates an interrupt event when the input text (plaintext or ciphertext) is consumed during the current cryptographic operation
0 = Does not generate an interrupt event when the input text is consumed

bit 9 **Unimplemented:** Read as '0'

bit 8 **CRYGO:** Cryptographic Engine Start bit(1)
1 = Starts the operation specified by OPMOD<3:0> (cleared automatically when operation is done)
0 = Stops the current operation (when cleared by software); also indicates the current operation has completed (when cleared by hardware)

Note 1: These bits are reset on system Resets or whenever the CRYMD bit is set.
2: Writes to these bit fields are locked out whenever an operation is in progress (CRYGO bit is set).
3: If the device enters Idle mode when CRYSIDL = 1, the module will stop its current operation. Entering into Idle mode while an OTP write operation is in process can result in irreversible corruption of the OTP.

REGISTER 22-5: CFGPAGE: SECURE ARRAY CONFIGURATION BITS (OTP PAGE 0) REGISTER (CONTINUED)

bit 19 **SKEYEN:** Session Key Enable bit

1 = Stored Key #1 may be used only as a Key Encryption Key
0 = Stored Key #1 may be used for any operation

bit 18-11 **LKYSRC<7:0>:** Locked Key Source Configuration bits

If SRCLCK = 1:
1xxxxxxx = Key Source is as if KEYSRC<3:0> = 1111
01xxxxxx = Key Source is as if KEYSRC<3:0> = 0111
001xxxxx = Key Source is as if KEYSRC<3:0> = 0110
0001xxxx = Key Source is as if KEYSRC<3:0> = 0101
00001xxx = Key Source is as if KEYSRC<3:0> = 0100
000001xx = Key Source is as if KEYSRC<3:0> = 0011
0000001x = Key Source is as if KEYSRC<3:0> = 0010
00000001 = Key Source is as if KEYSRC<3:0> = 0001
00000000 = Key Source is as if KEYSRC<3:0> = 0000

If SRCLCK = 0:
These bits are ignored.

bit 10 **SRCLCK:** Key Source Lock bit

1 = The key source is determined by the KEYSRC<3:0> (CRYCONH<3:0>) bits (software key selection is disabled)
0 = The key source is determined by the KEYSRC<3:0> (CRYCONH<3:0>) bits (locked key selection is disabled)

bit 9-1 **WRLOCK<8:0>:** Write Lock Page Enable bits

For OTP Pages 0 (CFGPAGE) through 8:
1 = OTP Page is permanently locked and may not be programmed
0 = OTP Page is unlocked and may be programmed

bit 0 **SWKYDIS:** Software Key Disable bit

1 = Software key (CRYKEY register) is disabled; when KEYSRC<3:0> = 0000, the KEYFAIL status bit will be set and no encryption/decryption/session key operations can be started until KEYSRC<3:0> bits are changed to a value other than '0000'
0 = Software key (CRYKEY register) can be used as a key source when KEYSRC<3:0> = 0000

Note 1: This bit's state is mirrored by the PGMTST bit (CRYOTP<7>).

REGISTER 29-4: CW4: FLASH CONFIGURATION WORD 4 (CONTINUED)

bit 4-0 **DSWDTPS<4:0>:** Deep Sleep Watchdog Timer Postscaler Select bits

11111 = 1:68,719,476,736 (25.7 days)
11110 = 1:34,359,738,368(12.8 days)
11101 = 1:17,179,869,184 (6.4 days)
11100 = 1:8,589,934592 (77.0 hours)
11011 = 1:4,294,967,296 (38.5 hours)
11010 = 1:2,147,483,648 (19.2 hours)
11001 = 1:1,073,741,824 (9.6 hours)
11000 = 1:536,870,912 (4.8 hours)
10111 = 1:268,435,456 (2.4 hours)
10110 = 1:134,217,728 (72.2 minutes)
10101 = 1:67,108,864 (36.1 minutes)
10100 = 1:33,554,432 (18.0 minutes)
10011 = 1:16,777,216 (9.0 minutes)
10010 = 1:8,388,608 (4.5 minutes)
10001 = 1:4,194,304 (135.3s)
10000 = 1:2,097,152 (67.7s)
01111 = 1:1,048,576 (33.825s)
01110 = 1:524,288 (16.912s)
01101 = 1:262,114 (8.456s)
01100 = 1:131,072 (4.228s)
01011 = 1:65,536 (2.114s)
01010 = 1:32,768 (1.057s)
01001 = 1:16,384 (528.5 ms)
01000 = 1:8,192 (264.3 ms)
00111 = 1:4,096 (132.1 ms)
00110 = 1:2,048 (66.1 ms)
00101 = 1:1,024 (33 ms)
00100 = 1:512 (16.5 ms)
00011 = 1:256 (8.3 ms)
00010 = 1:128 (4.1 ms)
00001 = 1:64 (2.1 ms)
00000 = 1:32 (1 ms)

TABLE 32-9: DC CHARACTERISTICS: I/O PIN OUTPUT SPECIFICATIONS

DC CHARACTERISTICS			Standard Operating Conditions: 2.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	**Symbol**	**Characteristic**	**Min**	**Typ(1)**	**Max**	**Units**	**Conditions**
	VOL	**Output Low Voltage**					
DO10		I/O Ports	—	—	0.4	V	IOL = 6.6 mA, VDD = 3.6V
			—	—	0.4	V	IOL = 5.0 mA, VDD = 2V
DO16		OSCO/CLKO	—	—	0.4	V	IOL = 6.6 mA, VDD = 3.6V
			—	—	0.4	V	IOL = 5.0 mA, VDD = 2V
	VOH	**Output High Voltage**					
DO20		I/O Ports	3.0	—	—	V	IOH = -3.0 mA, VDD = 3.6V
			2.4	—	—	V	IOH = -6.0 mA, VDD = 3.6V
			1.65	—	—	V	IOH = -1.0 mA, VDD = 2V
			1.4	—	—	V	IOH = -3.0 mA, VDD = 2V
DO26		OSCO/CLKO	2.4	—	—	V	IOH = -6.0 mA, VDD = 3.6V
			1.4	—	—	V	IOH = -1.0 mA, VDD = 2V

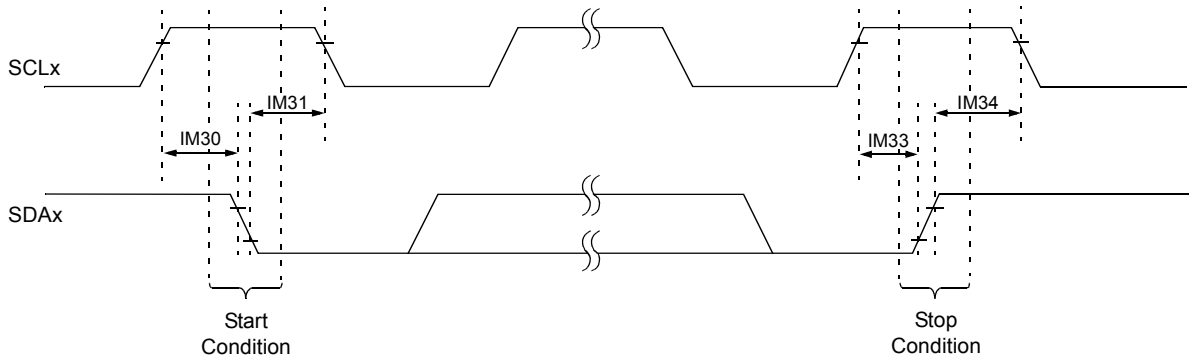
Note 1: Data in the "Typ" column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

TABLE 32-10: DC CHARACTERISTICS: PROGRAM MEMORY

DC CHARACTERISTICS			Standard Operating Conditions: 2.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	**Symbol**	**Characteristic**	**Min**	**Typ(1)**	**Max**	**Units**	**Conditions**
		Program Flash Memory					
D130	EP	Cell Endurance	20000	—	—	E/W	-40°C to +125°C
D131	VPR	VDD for Read	VMIN	—	3.6	V	VMIN = Minimum Operating Voltage
D132B		VDD for Self-Timed Write	VMIN	—	3.6	V	VMIN = Minimum Operating Voltage
D133A	TIW	Self-Timed Word Write Cycle Time	—	20	—	µs	
		Self-Timed Row Write Cycle Time	—	1.5	—	ms	
D133B	TIE	Self-Timed Page Erase Time	20	—	40	ms	
D134	TRETD	Characteristic Retention	20	—	—	Year	If no other specifications are violated
D135	IDDP	Supply Current during Programming	—	5	—	mA	
D136	VOTP	OTP Programming	3.1	—	3.6	V	
D137	TOTP	OTP Memory Write/Bit	—	500	—	µs	

Note 1: Data in the "Typ" column is at 3.3V, +25°C unless otherwise stated.

FIGURE 32-4: I²C™ BUS START/STOP BITS TIMING CHARACTERISTICS (MASTER MODE)



Note: Refer to Figure 32-2 for load conditions.

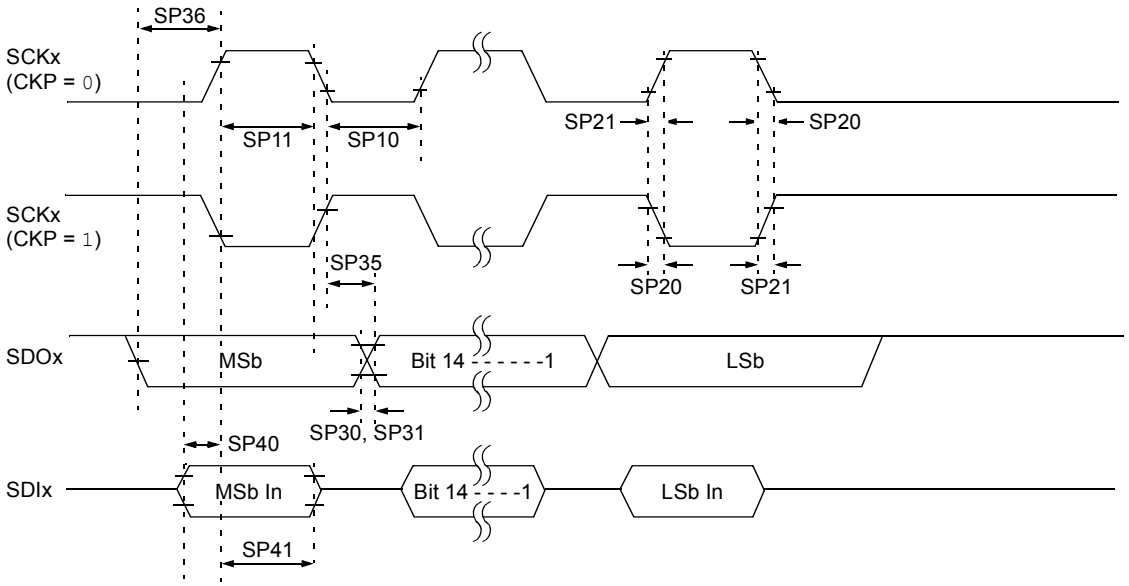
TABLE 32-22: I²C™ BUS START/STOP BIT TIMING REQUIREMENTS (MASTER MODE)

AC CHARACTERISTICS				Standard Operating Conditions: 2.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended			
Param No.	**Symbol**	**Characteristic**		**Min(1)**	**Max**	**Units**	**Conditions**
IM30	TSU:STA	Start Condition Setup Time	100 kHz mode	TCY (BRG + 1)	—	µs	Only relevant for Repeated Start condition
			400 kHz mode	TCY (BRG + 1)	—	µs	
			1 MHz mode(2)	TCY (BRG + 1)	—	µs	
IM31	THD:STA	Start Condition Hold Time	100 kHz mode	TCY (BRG + 1)	—	µs	After this period, the first clock pulse is generated
			400 kHz mode	TCY (BRG + 1)	—	µs	
			1 MHz mode(2)	TCY (BRG + 1)	—	µs	
IM33	TSU:STO	Stop Condition Setup Time	100 kHz mode	TCY (BRG + 1)	—	µs	
			400 kHz mode	TCY (BRG + 1)	—	µs	
			1 MHz mode(2)	TCY (BRG + 1)	—	µs	
IM34	THD:STO	Stop Condition Hold Time	100 kHz mode	TCY (BRG + 1)	—	ns	
			400 kHz mode	TCY (BRG + 1)	—	ns	
			1 MHz mode(2)	TCY (BRG + 1)	—	ns	

Note 1: BRG is the value of the I²C Baud Rate Generator. Refer to **Section 17.2 "Setting Baud Rate when Operating as a Bus Master"** for details.

2: Maximum Pin Capacitance = 10 pF for all I²C pins (for 1 MHz mode only).

FIGURE 32-14: SPIx MODULE MASTER MODE (CKE = 1) TIMING CHARACTERISTICS



Note: Refer to Figure 32-2 for load conditions.

TABLE 32-36: SPIx MODULE MASTER MODE (CKE = 1) TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 2.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	**Symbol**	**Characteristic(1)**	**Min**	**Typ(2)**	**Max**	**Units**	**Conditions**
SP10	TscL	SCKx Output Low Time(3)	TCY/2	—	—	ns	
SP11	TscH	SCKx Output High Time(3)	TCY/2	—	—	ns	
SP20	TscF	SCKx Output Fall Time(4)	—	—	—	ns	See Parameter DO32
SP21	TscR	SCKx Output Rise Time(4)	—	—	—	ns	See Parameter DO31
SP30	TdoF	SDOx Data Output Fall Time(4)	—	—	—	ns	See Parameter DO32
SP31	TdoR	SDOx Data Output Rise Time(4)	—	—	—	ns	See Parameter DO31
SP35	TscH2doV, TscL2doV	SDOx Data Output Valid After SCKx Edge	—	6	20	ns	
SP36	TdoV2sc, TdoV2scL	SDOx Data Output Setup to First SCKx Edge	30	—	—	ns	
SP40	TdiV2scH, TdiV2scL	Setup Time of SDIx Data Input to SCKx Edge	23	—	—	ns	
SP41	TscH2diL, TscL2diL	Hold Time of SDIx Data Input to SCKx Edge	30	—	—	ns	

Note 1: These parameters are characterized but not tested in manufacturing.

2: Data in "Typ" column is at 3.3V, +25°C unless otherwise stated.

3: The minimum clock period for SCKx is 100 ns. Therefore, the clock generated in Master mode must not violate this specification.

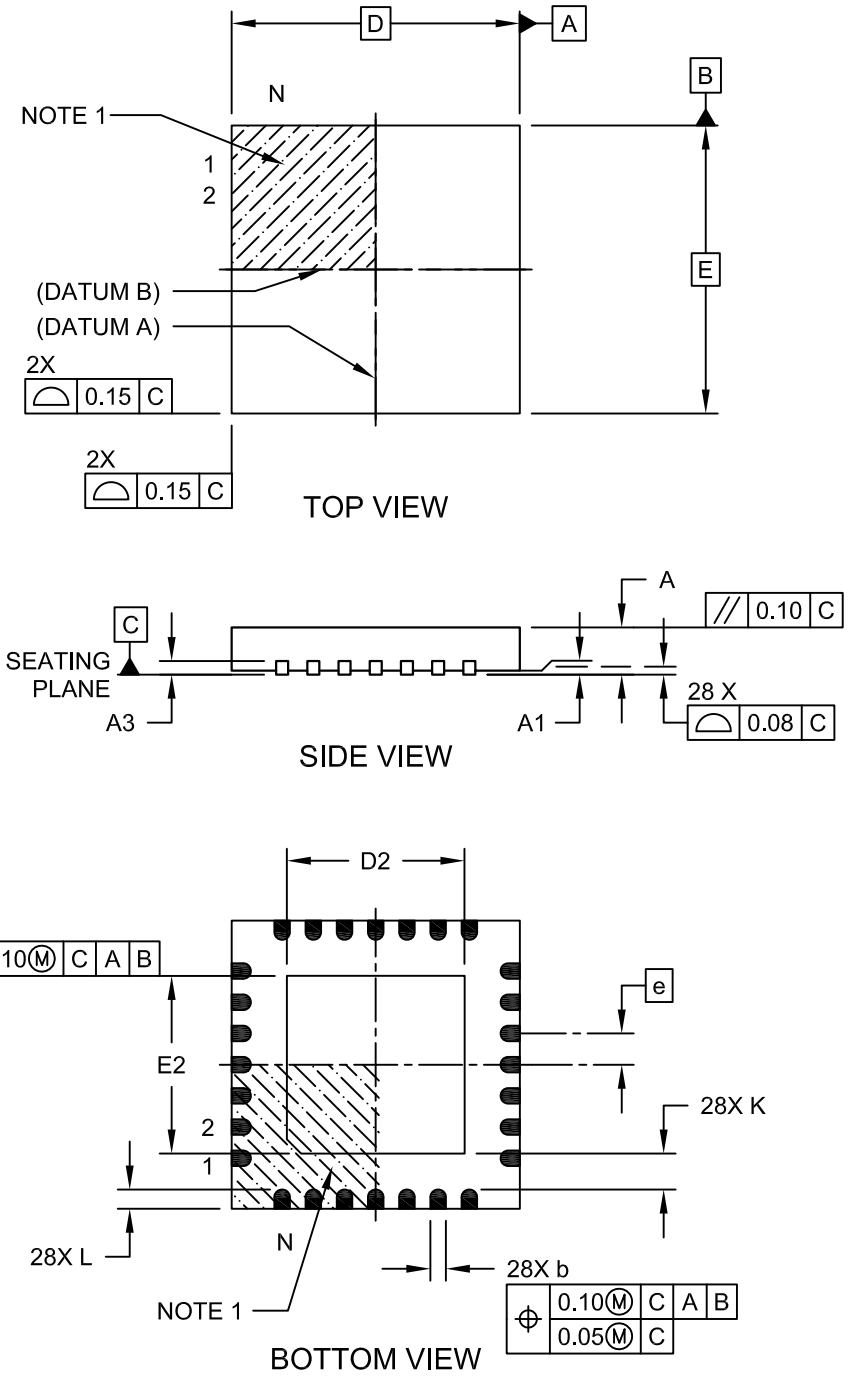
4: Assumes 50 pF load on all SPIx pins.

33.2 Package Details

The following sections give the technical details of the packages.

28-Lead Plastic Quad Flat, No Lead Package (MM) - 6x6x0.9mm Body [QFN-S] With 0.40 mm Terminal Length

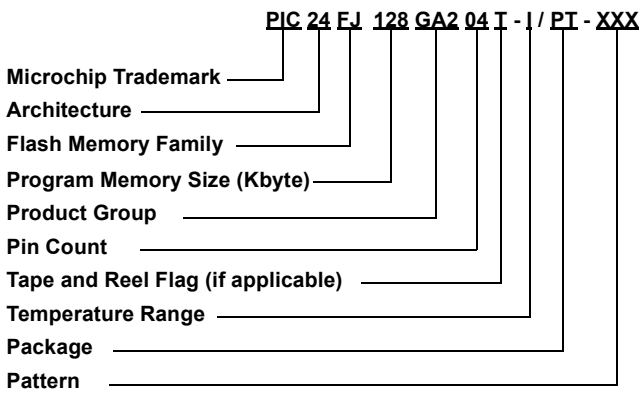
Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Microchip Technology Drawing C04-124C Sheet 1 of 2

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.



Architecture	24	= 16-bit modified Harvard without DSP
Flash Memory Family	FJ	= Flash program memory
Product Group	GA2	= General purpose microcontrollers
Pin Count	02 04	= 28-pin = 44-pin
Temperature Range	I E	= -40°C to +85°C (Industrial) = -40°C to +125°C (Extended)
Package	MM ML PT SO SP SS	= 28-lead (6x6x0.9 mm) QFN-S (Quad Flat) = 44-lead (8x8 mm) QFN (Quad Flat) = 44-lead (10x10x1 mm) TQFP (Thin Quad Flatpack) = 28-lead (7.50 mm wide) SOIC (Small Outline) = 28-lead (300 mil) SPDIP (Skinny Plastic Dual In-Line) = 28-lead (5.30 mm) SSOP (Plastic Shrink Small Outline)
Pattern	Three-digit QTP, SQTP, Code or Special Requirements (blank otherwise) ES = Engineering Sample	

Examples:

a) PIC24FJ128GA202-I/MM:
PIC24F device with 128-Kbyte program memory, 8-Kbyte data memory, 28-pin, Industrial temp., QFN-S package.

b) PIC24FJ128GA204-I/PT:
PIC24F device with 128-Kbyte program memory, 8-Kbyte data memory, 44-pin, Industrial temp., TQFP package.